L Number	Hits	Search Text	DB	Time stamp
1	471	((118/720) or (118/721)).CCLS.	USPAT;	2003/12/09 17:28
.*		, , , , , , , , , , , , , , , , , , , ,	US-PGPUB	
2	3	sacher-joachim.in.	USPAT;	2003/12/09 17:28
			US-PGPUB	
3	63	(156/345.3).CCLS.	USPAT;	2003/12/09 17:28
١.			US-PGPUB	
4	630	(118/504).CCLS.	USPAT;	2003/12/09 17:28
	453	//110/700\ /110/701\\ GOTG	US-PGPUB	0000/10/00 17 07
] -	453	((118/720) or (118/721)).CCLS.	USPAT; US-PGPUB	2003/12/09 17:27
_	0	(((118/720) or (118/721)).CCLS.) and	USPAT;	2003/12/09 17:27
		(laser with shutter with individual)	US-PGPUB	2003/12/09 17.27
_	2	(((118/720) or (118/721)).CCLS.) and	USPAT;	2003/03/21 09:32
		(laser with shutter)	US-PGPUB	2000, 00, 22 0, 100
_	1	("5980975").PN.	USPAT;	2003/03/21 09:32
			US-PGPUB	
-	11	(((118/720) or (118/721)).CCLS.) and	USPAT;	2003/03/21 12:40
		(shutter with (individual multipl\$5	US-PGPUB	
	l	plural\$5))		
-	104	(118/\$.CCLS.) and (shutter with	USPAT;	2003/06/27 14:04
1_	37	(individual multipl\$5 plural\$5))	US-PGPUB	1 2002 (02 (03 12 12
-	27	("2432950" "2571167" "2765765" "2906235" "2978364" "3063867"	USPAT	2003/03/21 12:48
	1	"2906235" "2978364" "3063867" "3117025" "3352282" "3371138"		
		"3502051" "3504325" "3549414"		
1		"3573672" "3600675" "3670693"		
		"3756851" "3773541" "3866155"		
		"3963982" "3992760" "4093914"		
		"4107349" "4122147" "4323031"		
		"4343827" "4378382" "4391034").PN.		
-	8	("3853740" "4051010" "4410407"	USPAT	2003/03/21 13:04
		"4894132" "5076205" "5241152"		1
	4.50	"5490912" "5665214").PN.		/ /
_	460	shutter with (individual multipl\$5	USPAT;	2003/03/21 13:22
		plural\$5) with (substrate wafer semiconsuctor laser)	US-PGPUB	
l _	413	(shutter with (individual multipl\$5	USPAT;	2003/03/21 13:19
	413	plural\$5) with (substrate wafer	US-PGPUB	2003/03/21 13:19
		semiconsuctor laser)) not ((118/\$.CCLS.)	05 10105	
		and (shutter with (individual multipl\$5		
		plural\$5)))		
_	277		USPAT;	2003/03/21 13:25
		plural\$5) with (substrate wafer	US-PGPUB	
		semiconductor)) and (deposit\$3 coat\$3		1
	077	(form\$3 with film))	Habra	2002/05/07 10 5-
-	277	(shutter with (individual multipl\$5 plural\$5 each) with (substrate wafer	USPAT;	2003/06/27 12:56
		pluralss each; with (substrate water semiconductor)) and (deposit\$3 coat\$3	US-PGPUB	1
İ		(form\$3 with film))		1
_	91	(shutter with (individual multipl\$5	EPO; JPO;	2003/03/21 13:28
		plural\$5 each) with (substrate wafer	DERWENT	-332, 33, 21 13.20
		semiconductor)) and (deposit\$3 coat\$3		
		(form\$3 with film))		
_	143	(individual\$3 with (shutter shield) with	USPAT;	2003/06/27 13:23
		(coat\$3 deposit\$3))	US-PGPUB	1
-	60	((individual\$3 with (shutter shield)) same	EPO; JPO;	2003/06/27 13:23
_	457	(coat\$3 deposit\$3))	DERWENT	2003/05/03 10 51
-	457	((118/720) or (118/721)).CCLS.	USPAT;	2003/06/27 13:51
_	5	(((118/720) or (118/721)).CCLS.) and	US-PGPUB USPAT;	2003/06/27 13:53
	3	((individual each) with (shutter shield))	US-PGPUB	2003/00/2/ 13:53
	53	(156/345.3).CCLS.	USPAT;	2003/12/09 17:28
			US-PGPUB	
-	69	(118/\$.CCLS.) and ((shield shutter) with	USPAT;	2003/06/27 14:13
		(individual))	US-PGPUB	
-	607	(118/504).CCLS.	USPAT;	2003/12/09 17:28
			US-PGPUB	
-	1	("5433785").PN.	USPAT;	2003/06/27 17:51
	2.1	E 4 2 2 7 0 E ITD DN	US-PGPUB	0000 (00 (00 40 50
	21]	5433785.URPN.	USPAT	2003/06/27 17:37

_	0	("2andtemperature").PN.	USPAT;	2003/06/27 17:51
- *	19	5433785.URPN. and temperature	US-PGPUB USPAT; US-PGPUB	2003/06/27 17:55